

# APPROVAL SHEET

MULTILAYER CERAMIC CAPACITORS

High Q / Low ESR Series (HH)

0402, 0603 & 0805 Sizes

**NP0** Dielectric

**RoHS Compliance** 

\*Contents in this sheet are subject to change without prior notice.



#### 1. INTRODUCTION

MLCC consists of a conducting material and electrodes. To manufacture a chip-type SMT and achieve miniaturization, high density and high efficiency, ceramic condensers are used.

WTC HH series MLCC is used at high frequencies generally have a small temperature coefficient of capacitance, typical within the ±30ppm/°C required for NP0 (C0G) classification and have excellent conductivity internal electrode. Thus, WTC HH series MLCC will be with the feature of low ESR and high Q characteristics.

## 2. FEATURES

- a. High Q and low ESR performance at high frequency.
- b. Quality improvement of telephone calls for low power loss and better performance.

#### 3. APPLICATIONS

- a. Mobile telecommunication: Mobile phone, WLAN.
- b. RF module: Power amplifier, VCO.
- c. Tuners.

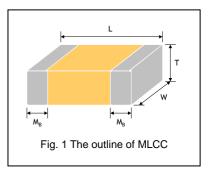
## 4. HOW TO ORDER

<u>HH</u>	<u>15</u>	<u>N</u>	<u>100</u>	<u>G</u>	<u>500</u>	<u>C</u>	I
<u>Series</u>	<u>Size</u>	<u>Dielectric</u>	<u>Capacitance</u>	<u>Tolerance</u>	Rated voltage	<u>Termination</u>	<u>Packaging</u>
<b>HH</b> =High Q/ Low ESR	<b>15</b> =0402 (1005) <b>18</b> =0603 (1608) <b>21</b> =0805 (2012)	<b>N</b> =NP0 (C0G)	Two significant digits followed by no. of zeros. And R is in place of decimal point.	B=±0.1pF C=±0.25pF D=±0.5pF F=±1% G=±2%	Two significant digits followed by no. of zeros. And R is in place of decimal point.	L=Ag/Ni/Sn C=Cu/Ni/Sn	T=7" reeled G=13" reeled
			eg.: R47=0.47pF 0R5=0.5pF 1R0=1.0pF 100=10x10 <sup>0</sup> =10pF	<b>J</b> =±5%	160=16 VDC 250=25 VDC 500=50 VDC 101=100 VDC 201=200 VDC 251=250 VDC 501=500 VDC 631=630 VDC		



## **5. EXTERNAL DIMENSIONS**

Size Inch (mm)	L (mm)	W (mm)	T (mm)/Sym	bol	Remark	M <sub>B</sub> (mm)
0402 (1005)	1.00±0.05	0.50±0.05	0.50±0.05	N	#	0.25 +0.05/-0.10
0000 (4000)	1.60±0.10	0.80±0.10	0.80±0.07	s		0.40.0.45
0603 (1608)	1.60 +0.15/-0.10	0.80 +0.15/-0.10	0.80 +0.15/-0.10	х		0.40±0.15
			0.60±0.10	Α		
0805 (2012)	2.00±0.15	1.25±0.10	0.80±0.10	В		0.50±0.20
			1.25±0.10	D	#	



## **6. GENERAL ELECTRICAL DATA**

Dielectric	NP0			
Size	0402, 0603, 0805			
	0402: 0.5pF to 470pF**			
Capacitance*	0603: 0.5pF to 3300pF			
	0805: 0.5pF to 390pF			
	Cap≤5pF: B (±0.1pF), C (±0.25pF)			
Capacitance tolerance	5pF <cap<10pf: (±0.25pf),="" (±0.5pf)<="" c="" d="" td=""></cap<10pf:>			
	Cap≥10pF: F (±1%), G (±2%), J (±5%)			
Rated voltage (WVDC)	16V, 25V, 50V, 100V, 200V, 250V, 500V, 630V			
Q*	Cap<30pF: Q≥400+20C			
<u>u</u>	Cap≥30pF: Q≥1000			
Insulation resistance at Ur	≥10GΩ or RxC≥100Ω-F whichever is smaller.			
Operating temperature	-55 to +125℃			
Capacitance change ±30ppm				
Termination	Ni/Sn (lead-free termination)			

 $<sup>^{\</sup>star}$  Measured at the conditions of 25°C ambient temper ature and 30~70% related humidity.

Apply 1.0±0.2Vrms, 1.0MHz±10% for Cap≤1000pF and 1.0±0.2Vrms, 1.0kHz±10% for Cap>1000pF.

<sup>#</sup> Reflow soldering only is recommended.

<sup>\*\* 0402,</sup> Capacitance <0.5pF: On request.



# 7. CAPACITANCE RANGE

	DIELECTRIC							NP0						
	SIZE		0402			06		-			08	05		
	Rated Voltage	16	25	50	16	25	50	100	50	100	200	250	500	630
	0.5pF (0R5)	N^	N^	N^	S^	S^	S^	S^	В	В				
	0.6pF (0R6)	N^	N^	N^	S^	S^	S^	S^	В	В				
	0.7pF (0R7)	N^	N^	N^	S^	S^	S^	S^	В	В				
	0.8pF (0R8)	N^	N^	N^	S^	S^	S^	S^	В	В				
	0.9pF (0R9)	N^	N^	N^	S^	S^	S^	S^	В	В				
	1.0pF (1R0)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	1.2pF (1R2)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	1.5pF (1R5)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	1.8pF (1R8)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	2.2pF (2R2)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	2.7pF (2R7)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	3.3pF (3R3)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	3.9pF (3R9)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	4.7pF (4R7)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	5.6pF (5R6)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	6.8pF (6R8)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	8.2pF (8R2)	N^	N^	N^	S^	S^	S^	S^	В	В	В	В	В	В
	10pF (100)	N	N	N	S	S	S	S	В	В	В	В	В	В
	12pF (120)	N	N	N	S	S	S	S	В	В	В	В	В	В
	15pF (150)	N	N	N	S	S	S	S	В	В	В	В	В	В
	18pF (180)	N	N	N	S	S	S	S	В	В	В	В	В	В
	22pF (220)	N	N	N	S	S	S	S	В	В	В	В	В	В
Capacitance	27pF (270)	N	N	N	S	S	S	S	В	В	В	В	В	В
ita	33pF (330)	N	N	N	S	S	S	S	В	В	В	В	В	В
bac	39pF (390)	N	N	N	S	S	S	S	В	В	В	В	В	В
င်ဒ	47pF (470)	N	N	N	S	S	S	S	В	В	В	В	В	В
	56pF (560)	N	N	N	S	S	S	S	В	В	В	В	В	В
	68pF (680)	N	N	N	S	S	S	S	В	В	В	В	В	В
	82pF (820)	N	N	N	S	S	S	S	В	В	В	В	В	В
	100pF (101)	N	N	N	S	S	S	S	В	В	В	В	В	В
	120pF (121)	N	N	N	S	S	S	S	D	D	D	D	D	D
	150pF (151)	N	N	N	S	S	S	S	D	D	D	D	D	D
	180pF (181)	N N	N	N	S	S	S	S			D	D	D	D
	220pF (221)	N N	N	N N	S S	S S	S S	S			D	D D	D D	D
	270pF (271) 330pF (331)	N N	N N	N N	S	S	S	S			D D	D	D	D D
	390pF (391)	N N	N	N N				S				D	D	
	470pF (471)	N N	N	N N	S S	S S	S S	S			D	ט	ט	D
	560pF (561)	IN	IN	IN	S	S	S	S						
	680pF (681)				S	S	S	S						
	820pF (821)				S	S	S	S						
	1,000pF (102)				S	S	S	S						
	1,200pF (102)				X	X	X							
	1,500pF (152)				X	X	X							
	1,800pF (182)				X	X	X							
	2,200pF (222)				X	X	X							
	2,700pF (272)				X	X	X							
	3,300pF (332)				X	X	X							
	3,300pr (332)				^	^	^							1

<sup>1.</sup> The letter in cell is expressed the symbol of product thickness.

<sup>2.</sup> The letter in cell with "A" mark is expressed product with Ag/Ni/Sn terminations.

<sup>3. 0402,</sup> Capacitance <0.5pF: On request.

<sup>4.</sup> For more information about products with special capacitance or other data, please contact WTC local representative.



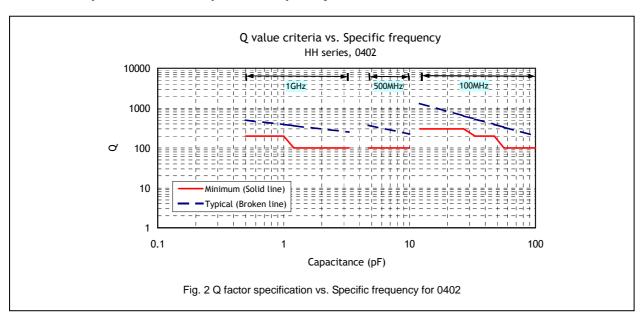
## **8. PACKAGING DIMENSION AND QUANTITY**

Size	Thickness (mm)/Symbol		Pape	r tape	Plastic tape	
Size			7" reel	13" reel	7" reel	13" reel
0402	0.50±0.05	N	10K	50K		
0603	0.80±0.07	S	4K	15K		
0003	0.80 +0.15/-0.10	X	41	15K		
	0.60±0.10	Α	41.	451.		
0805	0.80±0.10	В	4k	15k		
	1.25±0.10	D			3k	10k

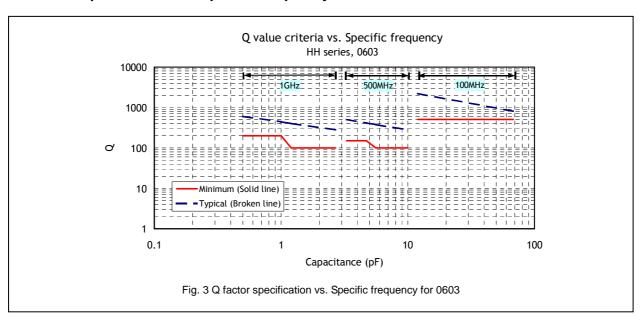
Unit: pieces

## 9. ELECTRICAL CHARACTERISTICS

### **Q** factor specification vs. Specific frequency

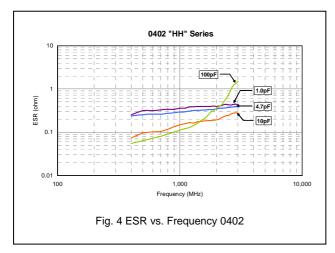


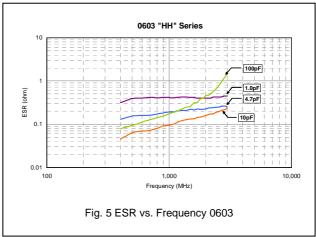
## Q factor specification vs. Specific frequency



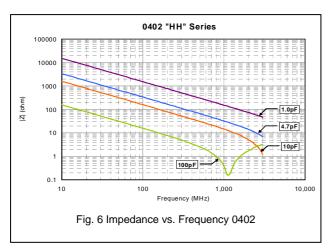


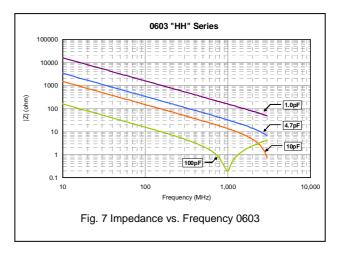
## **■** Typical ESR vs. Frequency



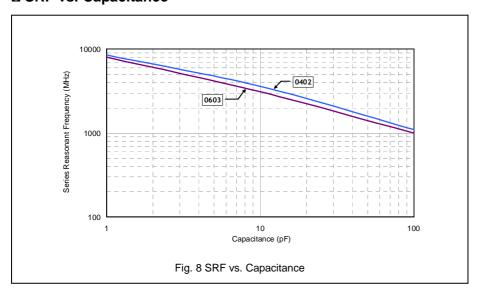


## **■** Typical Impedance vs. Frequency





## **■** SRF vs. Capacitance

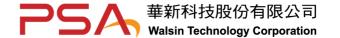




# 10. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

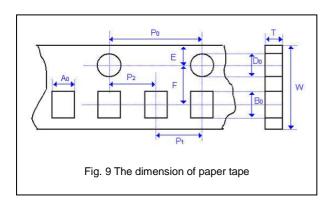
No.	Item	Test Conditions	Requirements
1.	Visual and		* No remarkable defect.
	Mechanical		* Dimensions to conform to individual specification sheet.
2.	Capacitance		* Shall not exceed the limits given in the detailed spec.
3.	Q/ D.F.	Cap>1000pF, 1.0±0.2Vrms, 1KHz±10%	* NP0: Cap≥30pF, Q≥1000; Cap<30pF, Q≥400+20C
	(Dissipation	At 25℃ ambient temperature.	
	Factor)		
4.	Dielectric	* To apply voltage: ( ≤100V ) 250% of rated voltage.	* No evidence of damage or flash over during test.
	Strength	* Duration: 1 to 5 sec.	
		* Charge and discharge current less than 50mA.	
		* To apply voltage:	
		200V~300V ≥2 times VDC	
		500V~999V ≥1.5 times VDC	
		* Cut-off, set at 10mA	
		* TEST= 15 sec.	
		* RAMP=0	
5.	Insulation	Rated voltage:<200V	≥10GΩ
	Resistance	To apply rated voltage for max. 120 sec.	
		Rated voltage:200~630V	≥10GΩ or RxC≥100Ω-F whichever is smaller
		To apply rated voltage (500V max.) for 60 sec.	
6.	Temperature	With no electrical load.	* Capacitance change: within ±30ppm/℃
	Coefficient	Operating temperature: -55~125℃ at 25℃	
7.	Adhesive	* Pressurizing force :	* No remarkable damage or removal of the terminations.
	Strength of	5N (≤0603) and 10N (>0603)	
	Termination	* Test time: 10±1 sec.	
8.	Vibration	* Vibration frequency: 10~55 Hz/min.	* No remarkable damage.
	Resistance	* Total amplitude: 1.5mm	* Cap change and Q/D.F.: To meet initial spec.
		* Test time: 6 hrs. (Two hrs each in three mutually	
		perpendicular directions.)	
		* Measurement to be made after keeping at room temp. for	
		24±2 hrs.	
9.	Solderability	* Solder temperature: 235±5℃	95% min. coverage of all metalized area.
		* Dipping time: 2±0.5 sec.	
10.	Bending Test	* The middle part of substrate shall be pressurized by means	* No remarkable damage.
		of the pressurizing rod at a rate of about 1 mm per second until	* Cap change: within ±5.0% or ±0.5pF whichever is larger.
		the deflection becomes 1 mm and then the pressure shall be	(This capacitance change means the change of capacitance under
		maintained for 5±1 sec.	specified flexure of substrate from the capacitance measured before
		* Measurement to be made after keeping at room temp. for	the test.)
		24±2 hrs.	
11.	Resistance to	* Solder temperature: 260±5℃	* No remarkable damage.
	Soldering Heat		* Cap change: within ±2.5% or ±0.25pF whichever is larger.
		* Preheating: 120 to 150℃ for 1 minute before imme rse the	* Q/D.F., I.R. and dielectric strength: To meet initial requirements.
		capacitor in a eutectic solder.	* 25% max. leaching on each edge.
		* Before initial measurement (Class II only): Perform	
		150+0/-10℃ for 1 hr and then set for 24±2 hrs at r oom temp.	
		* Measurement to be made after keeping at room temp. for	
		24±2 hrs.	

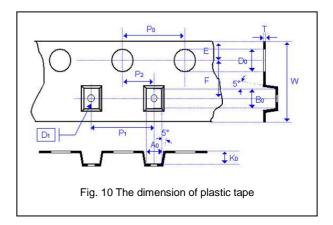
No.	Item	Test Condition	Requirements		
12.	Temperature Cycle	* Conduct the five cycles according to the temperatures and time.    Step   Temp. (°C)   Time (min.)	* No remarkable damage. * Cap change: within ±2.5% or ±0.25pF whichever is larger. * Q/D.F., I.R. and dielectric strength: To meet initial requirements.		
13.	Humidity (Damp Heat) Steady State	* Test temp.: 40±2°C  * Humidity: 90~95% RH  * Test time: 500+24/-0hrs.  *Before initial measurement (Class II only): Perform  150+0/-10°C for 1 hr and then set for 24±2 hrs at r oom temp  * Measurement to be made after keeping at room temp. for  24±2 hrs.	* No remarkable damage.  * Cap change: within ±5.0% or ±0.5pF whichever is larger.  * Q/D.F. value:  NP0: Cap≥30pF, Q≥350; 10pF≤Cap<30pF, Q≥275+2.5C  Cap<10pF; Q≥200+10C  * I.R.: ≥1GΩor RxC≥50Ω-F whichever is smaller.		
14.	Humidity (Damp Heat) Load	* Test temp.: 40±2°C  * Humidity: 90~95%RH  * Test time: 500+24/-0 hrs.  * To apply voltage: rated voltage (Max. 500V)  * Before initial measurement (Class II only): To apply test voltage for 1hr at 40°C and then set for 24±2 hrs at room temp. for 24±2 hrs.	* No remarkable damage.  * Cap change: within ±7.5% or ±0.75pF whichever is larger.  * Q/D.F. value:  NP0: Cap≥30pF, Q≥200; Cap<30pF, Q≥100+10/3C  * I.R.: ≥500MΩ or RxC≥25Ω-F whichever is smaller. p.		
15.	High Temperature Load (Endurance)	* Test temp.: NP0: 125±3°C  * To apply voltage: (1) <500V: 200% of rated voltage. (2) 500V: 150% of rated voltage. (3) ≥630V: 120% of rated voltage.  * Test time: 1000+24/-0 hrs.  *Before initial measurement (Class II only): To apply test voltage for 1hr at test temp. and then set for 24±2 hrs at roor temp.  *Measurement to be made after keeping at room temp. for 24±2 hrs	* No remarkable damage.  * Cap change: within ±3.0% or ±0.3pF whichever is larger.  * Q/D.F. value:  NP0: Cap≥30pF, Q≥350  10pF≤Cap<30pF, Q≥275+2.5C  Cap<10pF, Q≥200+10C  * I.R.: ≥1GΩ or RxC≥50Ω-F whichever is smaller.		



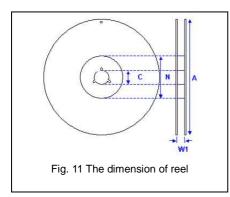
## **APPENDIXES**

## **■ Tape & reel dimensions**





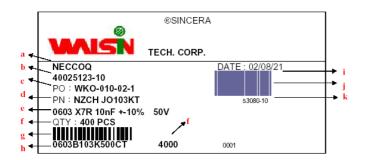
Size	0402	0603		0805	
Thickness	N	S, X	Α	В	C, D, I
A <sub>0</sub>	0.62±0.05	1.02±0.05	1.50±0.10	1.50±0.10	<1.57
B <sub>0</sub>	1.12±0.05	1.80±0.05	2.30±0.10	2.30±0.10	<2.40
Т	0.60±0.05	0.95±0.05	0.75±0.05	0.95±0.05	0.23±0.05
K <sub>0</sub>	-	-	-	-	<2.50
W	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10
P <sub>0</sub>	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
10xP <sub>0</sub>	40.0±0.10	40.0±0.10	40.0±0.10	40.0±0.10	40.0±0.10
P <sub>1</sub>	2.00±0.05	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
$P_2$	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
$D_0$	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05	1.50±0.05
D <sub>1</sub>	-	-	-	-	1.00±0.10
E	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.10
F	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05



Size	0402, 0603, 0805					
Reel size	7"	10"	13"			
С	13.0+0.5/-0.2	13.0+0.5/-0.2	13.0+0.5/-0.2			
$W_1$	8.4+1.5/-0	8.4+1.5/-0	8.4+1.5/-0			
Α	178.0±0.10	250.0±1.0	330.0±1.0			
N	60.0+1.0/-0	100.0±1.0	100±1.0			



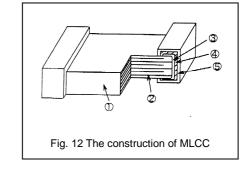
#### Description of customer label



- a. Customer name
- b. WTC order series and item number
- c. Customer P/O
- d. Customer P/N
- e. Description of product
- f. Quantity
- g. Bar code including quantity & WTC P/N or customer
- h. WTC P/N
- i. Shipping date
- j. Order bar code including series and item numbers
- k. Serial number of label

#### Constructions

No.	Na	me	NP0*	NP0
1	Ceramic	material	CaZrO <sub>3</sub> / Ba	aTiO₃ based
2	Inner el	ectrode	AgPd alloy	Ni
3		Inner layer	Ag	Cu
4	Termination	Middle layer	Ni	
(5)		Outer layer	S	'n



<sup>\*</sup> Partial NP0 items are with Ag/Ni/Sn(NME) terminations, please ref to product range for detail.

#### Storage and handling conditions

- (1) To store products at 5 to 40°C ambient temperature and 20 to 70%. related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

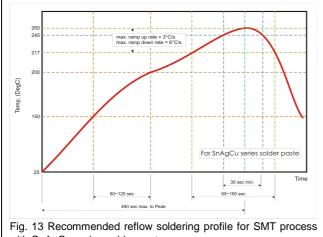
#### Cautions:

- a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
- b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.
- c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.



#### Recommended soldering conditions

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N<sub>2</sub> within oven are recommended.



with SnAgCu series solder paste.

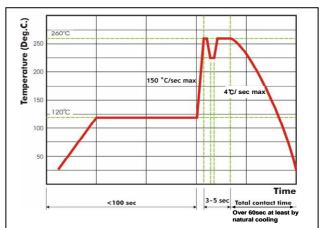


Fig. 14 Recommended wave soldering profile for SMT process with SnAgCu series solder.

## **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

### Walsin:

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HH15N5R6B500LT HH15N0R5B500CT HH15N100F500CT HH15N100J500CT HH15N101F500CT
HH15N101G500CT HH21N151J251CT HH18N102J500CT HH18N120J500CT HH18N150J500CT
HH18N470J500CT HH18N561F500CT HH18N820G500CT HH15N2R7B500CT HH15N3R3B500CT
HH18N0R5B500CT HH18N100J500CT HH18N101F500CT HH18N102F500CT HH15N120J500CT
HH15N150G500CT HH15N1R0B500CT HH15N1R6B500CT HH15N220F500CT HH15N220J500CT
HH15N2R2D500CT HH15N2R4C500CT HH15N2R7C500CT HH15N2R7D500CT HH15N300J500CT
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HH15N390F500CT HH15N390G500CT HH15N390J500CT HH15N391F160CT HH15N391J500CT
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